

Thyristor Module

$$V_{RRM} = 2 \times 1600 \text{ V}$$

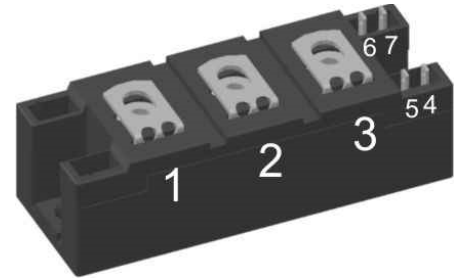
$$I_{TAV} = 181 \text{ A}$$

$$V_T = 1.03 \text{ V}$$

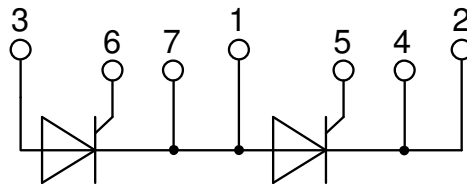
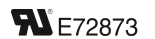
Phase leg

Part number

MCC162-16io1



Backside: isolated



Features / Advantages:

- Thyristor for line frequency
- Planar passivated chip
- Long-term stability
- Direct Copper Bonded Al₂O₃-ceramic

Applications:

- Line rectifying 50/60 Hz
- Softstart AC motor control
- DC Motor control
- Power converter
- AC power control
- Lighting and temperature control

Package: Y4

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

Terms .Conditions of usage:

The data contained in this product data sheet is exclusively intended for technically trained staff. The user will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to his application. The specifications of our components may not be considered as an assurance of component characteristics. The information in the valid application- and assembly notes must be considered. Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of your product, please contact the sales office, which is responsible for you.

Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact the sales office, which is responsible for you.

Should you intend to use the product in aviation, in health or live endangering or life support applications, please notify. For any such application we urgently recommend

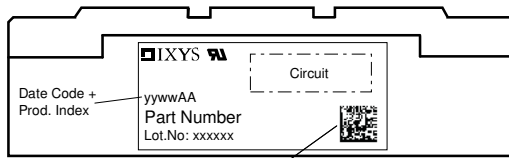
- to perform joint risk and quality assessments;

- the conclusion of quality agreements;

- to establish joint measures of an ongoing product survey, and that we may make delivery dependent on the realization of any such measures.

| Thyristor | | | Ratings | | | |
|----------------|--|--|-------------------------|------|-------|-------------------|
| Symbol | Definition | Conditions | min. | typ. | max. | Unit |
| $V_{RSM/DSM}$ | max. non-repetitive reverse/forward blocking voltage | $T_{VJ} = 25^{\circ}C$ | | | 1700 | V |
| $V_{RRM/DRM}$ | max. repetitive reverse/forward blocking voltage | $T_{VJ} = 25^{\circ}C$ | | | 1600 | V |
| I_{RD} | reverse current, drain current | $V_{R/D} = 1600 V$ | $T_{VJ} = 25^{\circ}C$ | | 300 | μA |
| | | $V_{R/D} = 1600 V$ | $T_{VJ} = 125^{\circ}C$ | | 10 | mA |
| V_T | forward voltage drop | $I_T = 150 A$ | $T_{VJ} = 25^{\circ}C$ | | 1.09 | V |
| | | $I_T = 300 A$ | | | 1.25 | V |
| | | $I_T = 150 A$ | $T_{VJ} = 125^{\circ}C$ | | 1.03 | V |
| | | $I_T = 300 A$ | | | 1.25 | V |
| I_{TAV} | average forward current | $T_C = 85^{\circ}C$ | $T_{VJ} = 125^{\circ}C$ | | 181 | A |
| $I_{T(RMS)}$ | RMS forward current | 180° sine | | | 300 | A |
| V_{T0} | threshold voltage | } for power loss calculation only | $T_{VJ} = 125^{\circ}C$ | | 0.88 | V |
| r_T | slope resistance | | | | 1.15 | m Ω |
| R_{thJC} | thermal resistance junction to case | | | | 0.155 | K/W |
| R_{thCH} | thermal resistance case to heatsink | | | 0.07 | | K/W |
| P_{tot} | total power dissipation | | $T_C = 25^{\circ}C$ | | 645 | W |
| I_{TSM} | max. forward surge current | $t = 10 ms$; (50 Hz), sine | $T_{VJ} = 45^{\circ}C$ | | 6.00 | kA |
| | | $t = 8,3 ms$; (60 Hz), sine | $V_R = 0 V$ | | 6.48 | kA |
| | | $t = 10 ms$; (50 Hz), sine | $T_{VJ} = 125^{\circ}C$ | | 5.10 | kA |
| | | $t = 8,3 ms$; (60 Hz), sine | $V_R = 0 V$ | | 5.51 | kA |
| I^2t | value for fusing | $t = 10 ms$; (50 Hz), sine | $T_{VJ} = 45^{\circ}C$ | | 180.0 | kA ² s |
| | | $t = 8,3 ms$; (60 Hz), sine | $V_R = 0 V$ | | 174.7 | kA ² s |
| | | $t = 10 ms$; (50 Hz), sine | $T_{VJ} = 125^{\circ}C$ | | 130.1 | kA ² s |
| | | $t = 8,3 ms$; (60 Hz), sine | $V_R = 0 V$ | | 126.3 | kA ² s |
| C_J | junction capacitance | $V_R = 400 V$ $f = 1 MHz$ | $T_{VJ} = 25^{\circ}C$ | | 273 | pF |
| P_{GM} | max. gate power dissipation | $t_p = 30 \mu s$ | $T_C = 125^{\circ}C$ | | 120 | W |
| | | $t_p = 500 \mu s$ | | | 60 | W |
| P_{GAV} | average gate power dissipation | | | | 8 | W |
| $(di/dt)_{cr}$ | critical rate of rise of current | $T_{VJ} = 125^{\circ}C$; $f = 50 Hz$ repetitive, $I_T = 540 A$ | | | 150 | A/ μs |
| | | $t_p = 200 \mu s$; $di_G/dt = 0.5 A/\mu s$; $I_G = 0.5 A$; $V = \frac{2}{3} V_{DRM}$ non-repet., $I_T = 180 A$ | | | 500 | A/ μs |
| $(dv/dt)_{cr}$ | critical rate of rise of voltage | $V = \frac{2}{3} V_{DRM}$ $R_{GK} = \infty$; method 1 (linear voltage rise) | $T_{VJ} = 125^{\circ}C$ | | 1000 | V/ μs |
| V_{GT} | gate trigger voltage | $V_D = 6 V$ | $T_{VJ} = 25^{\circ}C$ | | 2.5 | V |
| | | | $T_{VJ} = -40^{\circ}C$ | | 2.6 | V |
| I_{GT} | gate trigger current | $V_D = 6 V$ | $T_{VJ} = 25^{\circ}C$ | | 150 | mA |
| | | | $T_{VJ} = -40^{\circ}C$ | | 200 | mA |
| V_{GD} | gate non-trigger voltage | $V_D = \frac{2}{3} V_{DRM}$ | $T_{VJ} = 125^{\circ}C$ | | 0.2 | V |
| I_{GD} | gate non-trigger current | | | | 10 | mA |
| I_L | latching current | $t_p = 30 \mu s$ | $T_{VJ} = 25^{\circ}C$ | | 300 | mA |
| | | $I_G = 0.5 A$; $di_G/dt = 0.5 A/\mu s$ | | | | |
| I_H | holding current | $V_D = 6 V$ $R_{GK} = \infty$ | $T_{VJ} = 25^{\circ}C$ | | 200 | mA |
| t_{gd} | gate controlled delay time | $V_D = \frac{1}{2} V_{DRM}$ | $T_{VJ} = 25^{\circ}C$ | | 2 | μs |
| | | $I_G = 0.5 A$; $di_G/dt = 0.5 A/\mu s$ | | | | |
| t_q | turn-off time | $V_R = 100 V$; $I_T = 300 A$; $V = \frac{2}{3} V_{DRM}$ $di/dt = 10 A/\mu s$ $dv/dt = 20 V/\mu s$ $t_p = 200 \mu s$ | $T_{VJ} = 100^{\circ}C$ | | 150 | μs |

| Package Y4 | | | | Ratings | | | |
|---------------|--|----------------------|-------------------------------------|---------|------|------|--|
| Symbol | Definition | Conditions | min. | typ. | max. | Unit | |
| I_{RMS} | RMS current | per terminal | | | 300 | A | |
| T_{VJ} | virtual junction temperature | | -40 | | 125 | °C | |
| T_{op} | operation temperature | | -40 | | 100 | °C | |
| T_{stg} | storage temperature | | -40 | | 125 | °C | |
| Weight | | | | | 150 | g | |
| M_D | mounting torque | | 2.25 | | 2.75 | Nm | |
| M_T | terminal torque | | 4.5 | | 5.5 | Nm | |
| $d_{Spp/App}$ | creepage distance on surface striking distance through air | terminal to terminal | 14.0 | 10.0 | | mm | |
| $d_{Spb/Apb}$ | | terminal to backside | 16.0 | 16.0 | | mm | |
| V_{ISOL} | isolation voltage | t = 1 second | | | 3600 | V | |
| | | t = 1 minute | 50/60 Hz, RMS; $I_{ISOL} \leq 1$ mA | | 3000 | V | |



Data Matrix: Typ (1-19), DC+Prod.Index (20-25), FKT# (26-31)
leer (33), lfd.# (33-36)

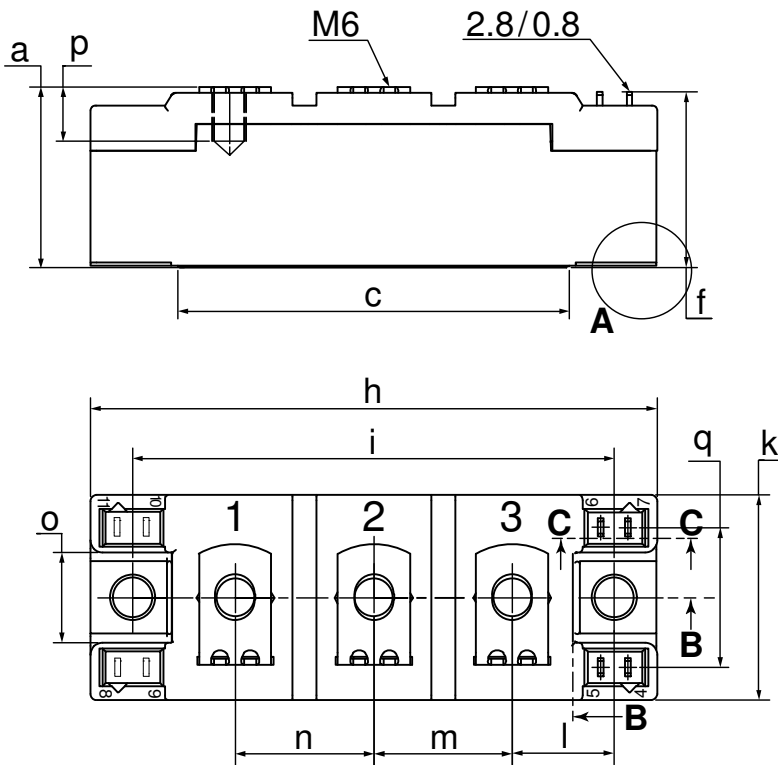
| Ordering | Ordering Number | Marking on Product | Delivery Mode | Quantity | Code No. |
|----------|-----------------|--------------------|---------------|----------|----------|
| Standard | MCC162-16io1 | MCC162-16io1 | Box | 6 | 429619 |

Equivalent Circuits for Simulation * on die level $T_{VJ} = 125^\circ\text{C}$

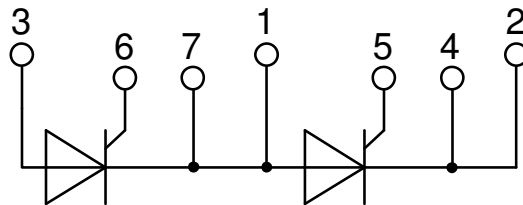
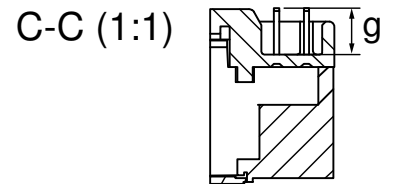
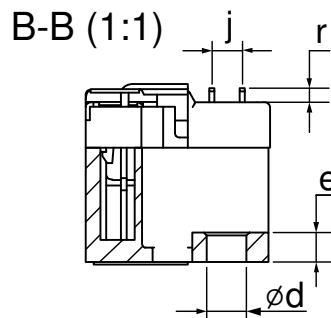
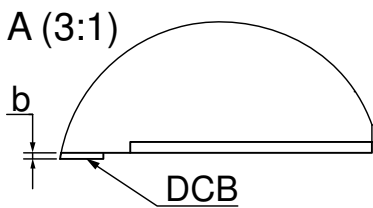
Thyristor

| | | | |
|--------------|--------------------|------|----|
| $V_{0\ max}$ | threshold voltage | 0.88 | V |
| $R_{0\ max}$ | slope resistance * | 0.8 | mΩ |

Outlines Y4



| Dim. | MIN [mm] | MIN [mm] | MIN [inch] | MIN [inch] |
|------|-----------|----------|------------|------------|
| a | 30.0 | 30.6 | 1.181 | 1.205 |
| b | typ. 0.25 | | typ. 0.010 | |
| c | 64.0 | 65.0 | 2.520 | 2.559 |
| d | 6.5 | 7.0 | 0.256 | 0.275 |
| e | 4.9 | 5.1 | 0.193 | 0.201 |
| f | 28.6 | 29.2 | 1.126 | 1.150 |
| g | 7.3 | 7.7 | 0.287 | 0.303 |
| h | 93.5 | 94.5 | 3.681 | 3.720 |
| i | 79.5 | 80.5 | 3.130 | 3.169 |
| j | 4.8 | 5.2 | 0.189 | 0.205 |
| k | 33.4 | 34.0 | 1.315 | 1.339 |
| l | 16.7 | 17.3 | 0.657 | 0.681 |
| m | 22.7 | 23.3 | 0.894 | 0.917 |
| n | 22.7 | 23.3 | 0.894 | 0.917 |
| o | 14.0 | 15.0 | 0.551 | 0.591 |
| p | typ. 10.5 | | typ. 0.413 | |
| q | 22.8 | 23.3 | 0.898 | 0.917 |
| r | 1.8 | 2.4 | 0.071 | 0.041 |



Thyristor

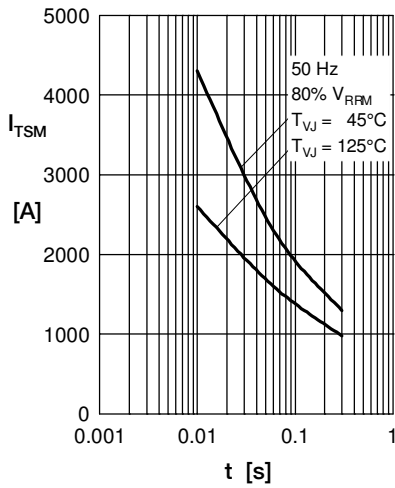


Fig. 1 Surge overload current I_{TSM} , I_{FSM} : Crest value, t : duration

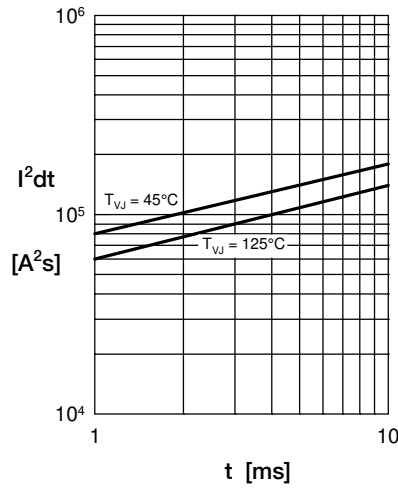


Fig. 2 I^2dt versus time (1-10 ms)

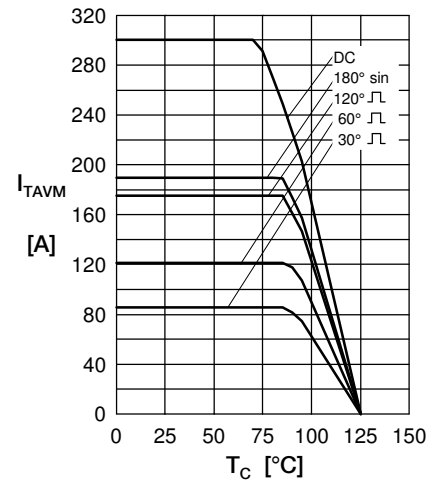


Fig. 3 Max. forward current at case temperature

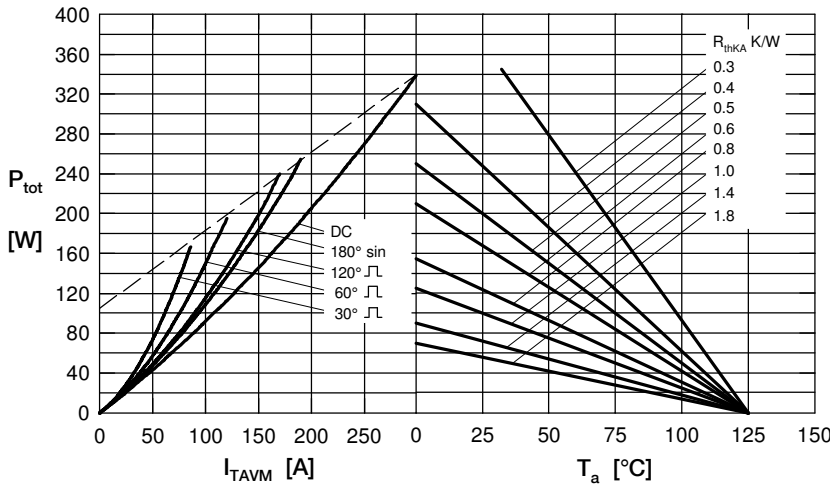


Fig. 4 Power dissipation vs. on-state current & ambient temperature (per thyristor or diode)

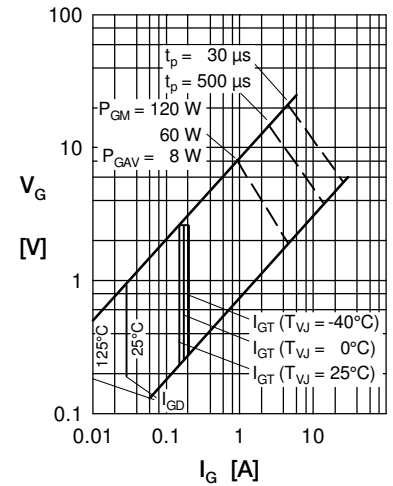


Fig. 5 Gate trigger characteristics

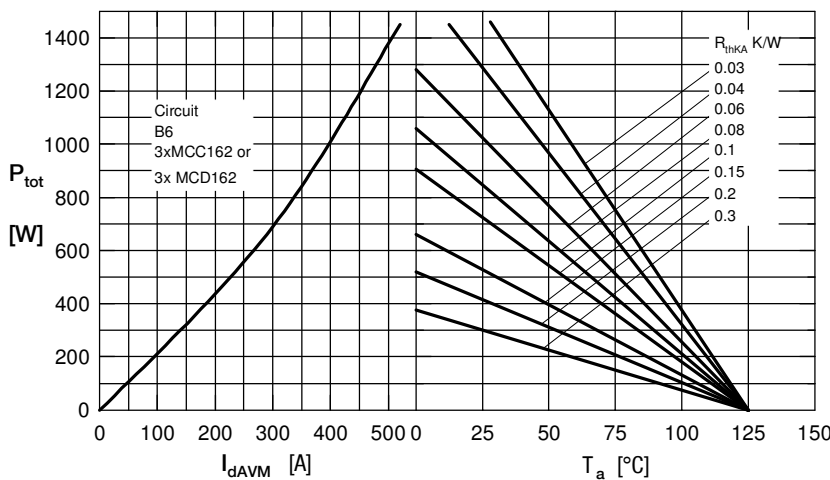


Fig. 6 Three phase rectifier bridge: Power dissipation versus direct output current and ambient temperature

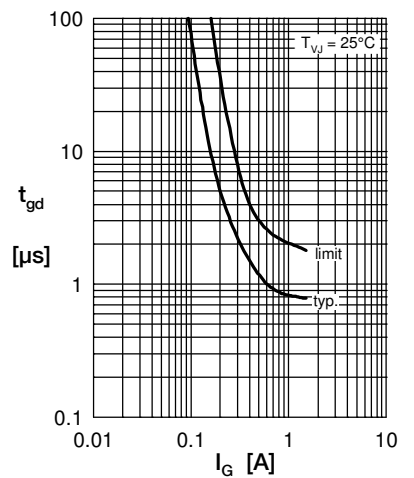


Fig. 7 Gate trigger delay time

Thyristor

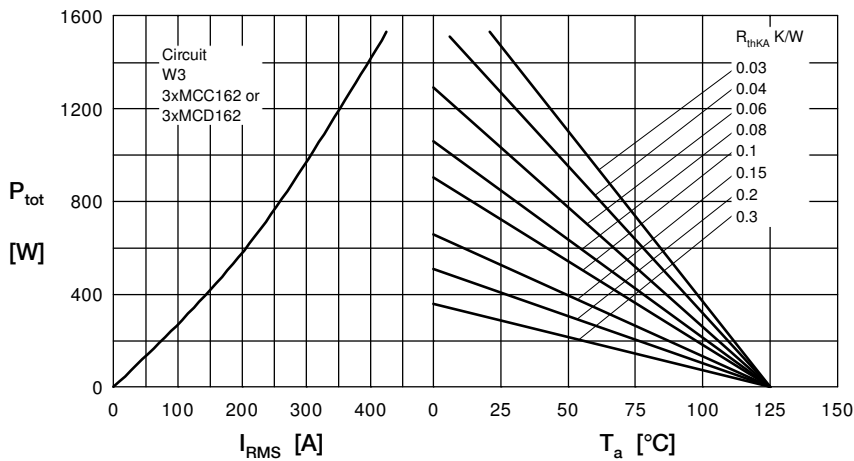
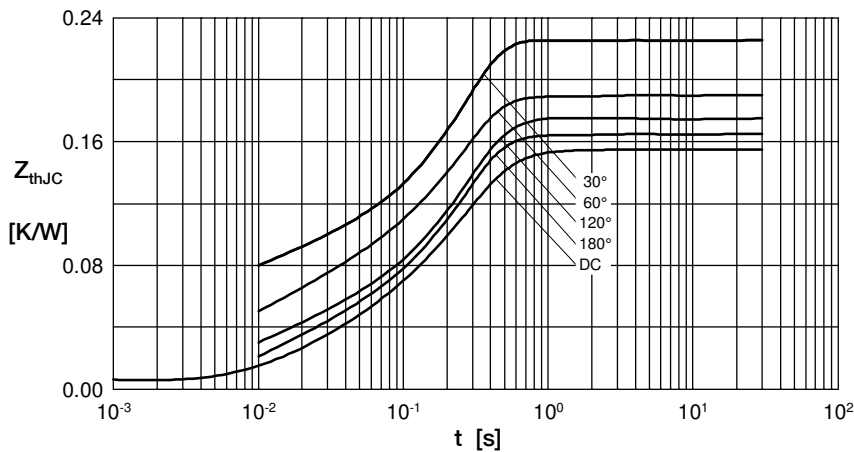


Fig. 8 Three phase AC-controller: Power dissipation versus RMS output current and ambient temperature



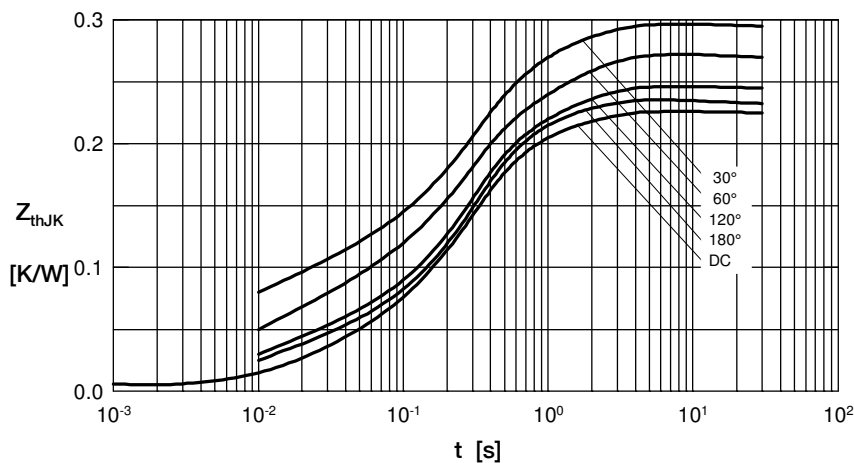
R_{thJC} for various conduction angles d:

| d | R_{thJC} [K/W] |
|------|------------------|
| DC | 0.155 |
| 180° | 0.167 |
| 120° | 0.176 |
| 60° | 0.197 |
| 30° | 0.227 |

Constants for Z_{thJC} calculation:

| i | R_{thi} [K/W] | t_i [s] |
|---|-----------------|-----------|
| 1 | 0.0072 | 0.001 |
| 2 | 0.0188 | 0.080 |
| 3 | 0.1290 | 0.200 |

Fig. 9 Transient thermal impedance junction to case (per thyristor/diode)



R_{thJK} for various conduction angles d:

| d | R_{thJK} [K/W] |
|------|------------------|
| DC | 0.225 |
| 180° | 0.237 |
| 120° | 0.246 |
| 60° | 0.267 |
| 30° | 0.297 |

Constants for Z_{thJK} calculation:

| i | R_{thi} [K/W] | t_i [s] |
|---|-----------------|-----------|
| 1 | 0.0072 | 0.001 |
| 2 | 0.0188 | 0.080 |
| 3 | 0.1290 | 0.200 |
| 4 | 0.0700 | 1.000 |

Fig. 10 Transient thermal impedance junction to heatsink (per thyristor/diode)